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IP4041CX25

10-channel integrated filter network with ESD input protection to IEC 61000-4-2 level 4

Rev. 01 — 12 February 2010

Product data sheet

1. Product profile

1.1 General description

The IP4041CX25 is a 10-channel RC low-pass filter array which is designed to provide filtering of undesired RF signals. In addition, the IP4041CX25 incorporates diodes to provide protection to downstream components from ElectroStatic Discharge (ESD) voltages as high as ± 20 kV contact according the IEC 61000-4-2 standard, far exceeding level 4.

The IP4041CX25 is fabricated using monolithic silicon technology and integrates 10 resistors and 20 diodes in a single Wafer-Level Chip-Scale Package (WLCSP). These features make the IP4041CX25 ideal for use in applications requiring the utmost in miniaturization such as mobile phone handsets, cordless telephones and personal digital devices.

1.2 Features and benefits

- Pb-free, RoHS compliant and free of halogen and antimony (Dark Green compliant)
- 10-channel integrated π-type RC filter network
- 200 Ω series resistance; 50 pF (typical) channel capacitance
- Integrated ESD protection withstanding ±20 kV contact discharge, far exceeding IEC 61000-4-2 level 4
- WLCSP with 0.5 mm pitch

1.3 Applications

Reduce ElectroMagnetic Interference (EMI) and Radio Frequency Interference (RFI) and provide downstream ESD protection for:

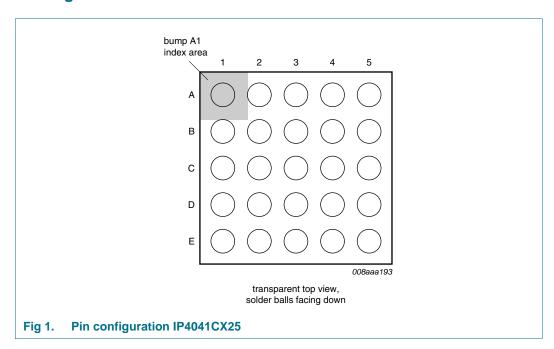
- Cellular and Personal Communication System (PCS) mobile handsets
- Cordless telephones
- Other appliances with low frequency signals (e.g. keypads)
- Wireless data (WAN/LAN) systems and PDAs



10-channel integrated filter network with ESD input protection

2. Pinning information

2.1 Pinning



2.2 Pin description

Table 1. Pinning

3	
Pin	Description
A1 and E1	filter channel 1
A2 and E2	filter channel 2
A3 and E3	filter channel 3
A4 and E4	filter channel 4
A5 and E5	filter channel 5
B1 and D1	filter channel 6
B2 and D2	filter channel 7
B3 and D3	filter channel 8
B4 and D4	filter channel 9
B5 and D5	filter channel 10
C1 to C5	ground

3. Ordering information

Table 2. Ordering information

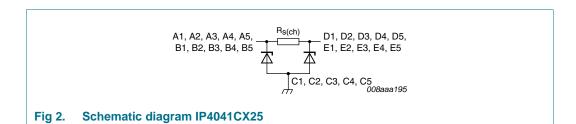
Table 21 Ordering members					
Type number	Package	Package			
	Name	Description	Version		
IP4041CX25	WLCSP25	wafer level chip-size package; 25 bumps; 2.41 × 2.41 × 0.65 mm	IP4041CX25		

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4. Functional diagram



5. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{I}	input voltage		-0.5	+5.5	V
V_{ESD}	electrostatic discharge voltage	all pins to ground			
		contact discharge	<u>[1]</u> –20	+20	kV
		air discharge	<u>[1]</u> –20	+20	kV
		IEC 61000-4-2 level 4; all pins to ground			
		contact discharge	-8	+8	kV
		air discharge	-15	+15	kV
P _{ch}	channel power dissipation	continuous power; T _{amb} = 70 °C	-	50	mW
P _{tot}	total power dissipation	continuous power; T _{amb} = 70 °C	-	500	mW
T _{stg}	storage temperature		-55	+150	°C
T _{reflow(peak)}	peak reflow temperature	10 s maximum	-	260	°C
T _{amb}	ambient temperature		-35	+85	°C

^[1] Device is qualified with 1000 pulses of ± 15 kV contact discharges each, according to the IEC 61000-4-2 model and far exceeds the specified level 4 (8 kV contact discharge).

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6. Characteristics

Table 4. Channel characteristics

 $T_{amb} = 25$ °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{s(ch)}$	channel series resistance		180	200	220	Ω
C_{ch}	channel capacitance	$V_{bias(DC)} = 0 \text{ V; } f = 1 \text{ MHz}$	-	50	-	pF
V_{BR}	breakdown voltage	I _{test} = 1 mA	6	-	15	V
I _{LR}	reverse leakage current	per channel; V _I = 3.0 V	-	-	25	nA

Table 5. Frequency characteristics

 $T_{amb} = 25$ °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
α_{il}	insertion loss	R_{gen} = 50 Ω ; R_{L} = 50 Ω ; 800 MHz < f < 2.4 GHz	30	35	-	dB
α_{ct}	crosstalk attenuation	800 MHz < f < 6 GHz; $R_{gen} = 50 \Omega$; $R_L = 50 \Omega$				
		adjacent channels; input: A1; output: D1; B1 and E1 terminated by $50~\Omega$	-	-30	-20	dB
		distant channels; input: A1; output: E5; E1 and A5 terminated by $50~\Omega$	-	-36	-20	dB
		1.0 kHz < f < 800 MHz; $R_{gen} = 50 \Omega$; $R_{L} = 50 \Omega$				
		adjacent channels; input: A1; output: D1; B1 and E1 terminated by $50~\Omega$	-	-47	-30	dB
		distant channels; input: A1; output: E5; E1 and A5 terminated by 50 Ω	-	-55	-30	dB

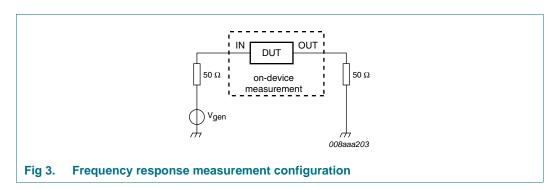
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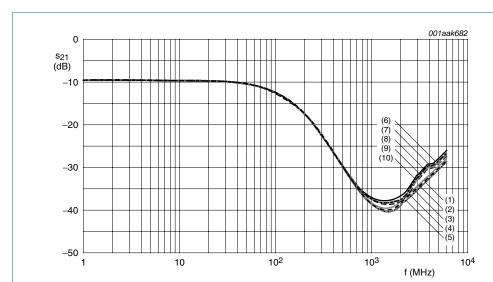
7. Application information

7.1 Insertion loss

The insertion loss measurement configuration of a typical 50 Ω NetWork Analyzer (NWA) system for evaluation of the IP4041CX25 is shown in Figure 3.

The insertion loss of all channels for frequencies up to 6 GHz is displayed in Figure 4.





- (1) Channel 10 (pins B5 and D5).
- (2) Channel 9 (pins B4 and D4).
- (3) Channel 8 (pins B3 and D3).
- (4) Channel 7 (pins B2 and D2).
- (5) Channel 6 (pins B1 and D1).
- (6) Channel 5 (pins A5 and E5).
- (7) Channel 4 (pins A4 and E4).
- (8) Channel 3 (pins A3 and E3).
- (9) Channel 2 (pins A2 and E2).
- (10) Channel 1 (pins A1 and E1).

Fig 4. Measured insertion loss magnitudes

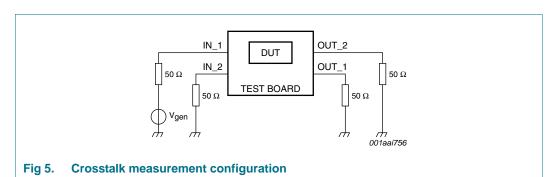
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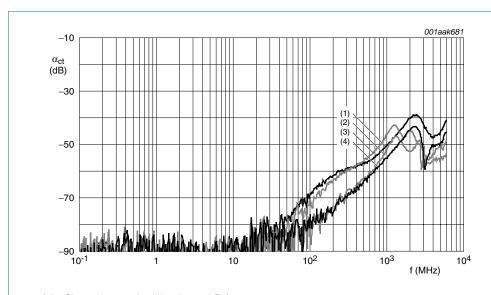
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7.2 Crosstalk

The crosstalk measurement configuration of a typical 50 Ω NWA system for evaluation of the IP4041CX25 is shown in Figure 5.

The measured crosstalk within the IP4041CX25 in a 50 Ω NWA system from one channel to another is shown in Figure 6 for different pairs of channels representing the worst case (channels 1 and 2, channels 6 and 7) and the best case (channels 6 and 10, channels 1 and 5) conditions in terms of physical distance. In all cases the crosstalk is measured for two pins. One is very close to the input while the other is relatively far away. Unused connections are terminated with 50 Ω to ground.





- (1) Channels 1 and 2 (pins A1 and E2).
- (2) Channels 6 and 10 (pins B1 and D5).
- (3) Channels 6 and 7 (pins B1 and D2).
- (4) Channels 1 and 5 (pins A1 and E5).

Fig 6. Measured crosstalk between adjacent channels

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8. Package outline

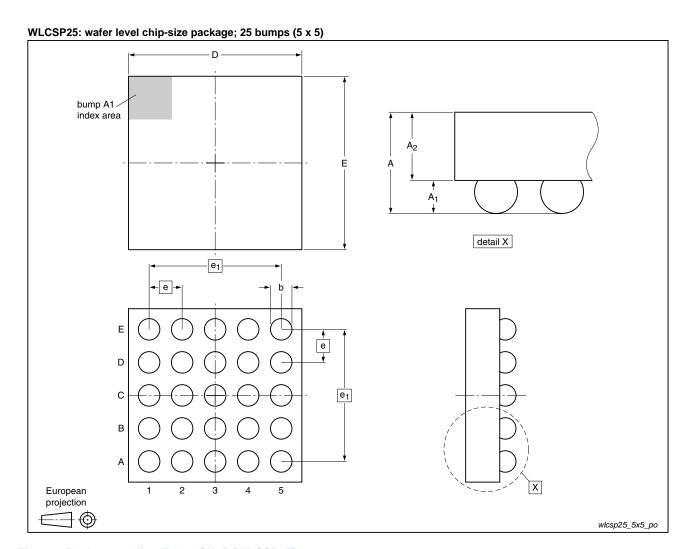


Fig 7. Package outline IP4041CX25 (WLCSP25)

Table 6. Dimensions for Figure 7

Symbol	Min	Тур	Max	Unit
A	0.60	0.65	0.70	mm
A ₁	0.22	0.24	0.26	mm
A ₂	0.38	0.41	0.44	mm
b	0.27	0.32	0.37	mm
D	2.36	2.41	2.46	mm
E	2.36	2.41	2.46	mm
е	-	0.5	-	mm
e ₁	-	2.0	-	mm

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9. Design and assembly recommendations

9.1 PCB design guidelines

For optimum performance it is recommended to use a Non-Solder Mask PCB Design (NSMD), also known as a copper-defined design, incorporating laser-drilled micro-vias connecting the ground pads to a buried ground-plane layer. This results in the lowest possible ground inductance and provides the best high frequency and ESD performance. For this case, refer to Table 7 for the recommended PCB design parameters.

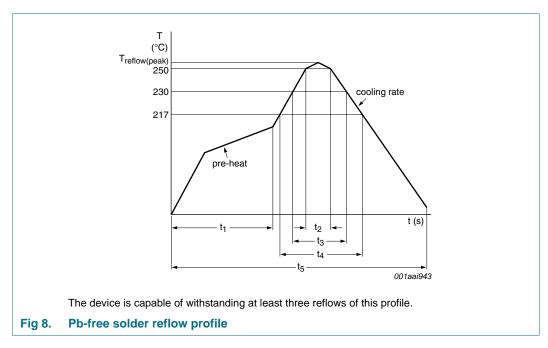
Table 7. Recommended PCB design parameters

•	
Parameter	Value or specification
PCB pad diameter	200 μm
Micro-via diameter	100 μm (0.004 inch)
Solder mask aperture diameter	370 μm
Copper thickness	20 μm to 40 μm
Copper finish	AuNi
PCB material	FR4

9.2 PCB assembly guidelines for Pb-free soldering

Table 8. Assembly recommendations

•	
Parameter	Value or specification
Solder screen aperture diameter	330 μm
Solder screen thickness	100 μm (0.004 inch)
Solder paste: Pb-free	SnAg (3 % to 4 %) Cu (0.5 % to 0.9 %)
Solder / flux ratio	50 / 50
Solder reflow profile	see Figure 8



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Table 9. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_{reflow(peak)} \\$	peak reflow temperature		230	-	260	°C
t ₁	time 1	soak time	60	-	180	S
t ₂	time 2	time during T \geq 250 $^{\circ}C$	-	-	30	S
t ₃	time 3	time during T \geq 230 $^{\circ}C$	10	-	50	S
t ₄	time 4	time during T > 217 $^{\circ}$ C	30	-	150	S
t ₅	time 5		-	-	540	S
dT/dt	rate of change of	cooling rate	-	-	-6	°C/s
temperature	pre-heat	2.5	-	4.0	°C/s	

10. Abbreviations

Table 10. Abbreviations

Table 10. Appreviations	
Acronym	Description
DUT	Device Under Test
EMI	ElectroMagnetic Interference
ESD	ElectroStatic Discharge
FR4	Flame Retard 4
LAN	Local Area Network
NSMD	Non-Solder Mask PCB Design
PCB	Printed-Circuit Board
PCS	Personal Communication System
RFI	Radio Frequency Interference
RoHS	Restriction of Hazardous Substances
WAN	Wide Area Network
WLCSP	Wafer-Level Chip-Scale Package

11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
IP4041CX25_1	20100212	Product data sheet	-	-

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12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
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